

N° 2021-113-A8

Dear customer,

please find attached our Infineon Technologies AG PCN:

Several changes affecting products TLE926x

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 2022-08-31.
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates:
 "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."
 Notwithstanding the aforesaid individual agreements shall prevail.

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.







On 16 April 2020, Infineon acquired Cypress.

We are now in the process of merging and consolidating our tools and processes for PCN, Information Notes, Errata and Product Discontinuance.

For further details, please visit our website:

https://www.infineon.com/cms/en/about-infineon/company/cypress-acquisition/

Infineon Technologies AG

Postal address D-81726 München Internet www.infineon.com Headquarters Am Campeon 1-15, D-85579 Neubiberg Phone +49 (0)89 234-0 Chairman of the Supervisory Board Dr. Wolfgang Eder

Management Board Jochen Hanebeck (CEO), Constanze Hufenbecher, Dr. Sven Schneider, Andreas Urschitz, Dr. Rutger Wijburg Registered office Neubiberg Commercial register Amtsgericht München HRB 126492



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Products affected

Please refer to attached affected product list PCN_2021-113-A8_[customer-no].pdf

Detailed change information

Subject: Several changes affecting products TLE926x

Reason/Motivation: Infineon is extending manufacturing capabilities and will enable product families at external manufacturing partners.

> Infineon has continuously extended its production capacity to meet strongly increasing market demand. This extension includes not only building up of new fabs or new lines but also optimization of production location and usage of outsourcing if necessary.

Infineon is ensuring business continuity and high supply security by optimizing and streamlining its production.

Description	<u>Old</u>	New
DATA SHEET: Change of datasheet parameters/electrical specification (min./max./typ. values) and/or AC/DC specification	Rev. 1.1	Rev. 1.2 (see links in 4_cip21113_A8)
DESIGN: Design changes in active elements	S9263C (Dresden)	S9263C (Dresden) AND S9263U (UMC)
DESIGN: Design changes in routing		S9263C (Dresden) AND S9263U (UMC)
PROCESS - WAFER PRODUCTION: New wafer diameter	200mm (Dresden)	200mm (Dresden) AND 300mm (UMC)
PROCESS - WAFER PRODUCTION: New final wafer thickness	220 μm (Dresden)	220 μm (Dresden) AND 230 μm (UMC)
PROCESS - WAFER PRODUCTION: New / change of metallization / vias / contacts	NiMoP	NiMoP AND Pro.Cu
PROCESS - WAFER PRODUCTION: Change in process technology not covered by any other type of change	•	Old process flow AND New process flows



encapsulation material

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PROCESS - WAFER PRODUCTION: Move	Locations:	Locations:
all or parts of production to a different	Dresden Split Flow:	Dresden Split Flow (200mm):
-	Infineon Technologies Dresden GmbH,	Infineon Technologies Dresden GmbH,
	Dresden, Germany	Dresden, Germany
	Infineon Technologies AG, Regensburg,	Infineon Technologies AG, Regensburg,
	Germany	Germany
	,	,
		AND
		UMC Split Flow 1 (300mm):
		United Microelectronics Corporation,
		Tainan, Taiwan
		Infineon Technologies Dresden GmbH,
		Dresden, Germany
		Dresden, dermany
		AND
		UMC Split Flow 2 (300mm):
		United Microelectronics Corporation,
		Tainan, Taiwan
		Infineon Technologies Dresden GmbH,
		Dresden, Germany
		Infineon Technologies AG, Regensburg,
		Germany
		,
PROCESS - ASSEMBLY:	PG-VQFN-48-31 (Melaka)	PG-VQFN-48-31/37 (Melaka)
Change in leadframe dimensions		AND
_		PG-VQFN-48-79 (Amkor)
PROCESS - ASSEMBLY:	PG-VQFN-48-31 (Melaka)	PG-VQFN-48-31/37 (Melaka)
Change of lead frame finishing material		AND
/ area (internal)		PG-VQFN-48-79 (Amkor)
PROCESS - ASSEMBLY:	CRM1079S (Melaka)	CRM1079S (Melaka)
Die attach material	· · ·	AND
		CRM1085A (Amkor)
PROCESS - ASSEMBLY:	PG-VQFN-48-31: Cu (Melaka)	PG-VQFN-48-31/37: Cu (Melaka)
Change of wire bonding	, , ,	PG-VQFN-48-79: PCC (palladium coated
-		copper) (Amkor)
PROCESS - ASSEMBLY:	EME G700 (Melaka)	EME G700 (Melaka)
Change of mold compound /		AND

EME G631 (Amkor)



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PROCESS - ASSEMBLY: Without serial number above the date Without serial number above the date Change of product marking code in line 3 (Melaka) code in line 3 (Melaka) AND With serial number above the date code in line 3 (Amkor) PROCESS - ASSEMBLY: Move all or Infineon Technologies (Malaysia) Sdn. Infineon Technologies (Malaysia) Sdn. parts of production to a different Bhd., Melaka, Malaysia Bhd., Melaka, Malaysia AND assembly site. Amkor Technology, INC. Muntinlupa City, Philippines **EQUIPMENT: Production from a new** Infineon tool park Infineon tool park equipment/tool which uses a different AND basic technology or which due to its SiFo and OSAT tool park unique form or function can be expected to influence the integrity of the final product

Product identification Wafer lot numbers from Dresden start with ZAxxxxxx.

Wafer lot numbers from UMC start with 6Hxxxxxx.

Traceability assured via date code.

SP number and ordering part number are different (see 5 cip21113 A8).

Anticipated impact of change

Based on the qualification performed, Infineon does not expect any negative impact on quality, function and reliability. No change in fit, form and function expected.

DeQuMa-ID(s): SEM-DS-01 / SEM-DE-01 / SEM-DE-02 / SEM-PW-02 / SEM-PW-03 / SEM-PW-07 / SEM-PW-09 / SEM-PW-13 / SEM-PA-03 / SEM-PA-04 / SEM-PA-07 / SEM-PA-08 / SEM-PA-11 / SEM-PA-13 / SEM-PA-18 / SEM-EQ-01

Attachments PCN_2021-113-A8_[customer-no].pdf affected product list

4_cip21113_A8 MyICP links
5_cip21113_A8 SP list comparison

Time schedule

Final qualification report	available
First samples available	on request
Intended start of delivery [1]	2023-01-30
Last order date (LOD) [2]	2023-01-30
Last delivery date (LDD) [3]	2024-01-30

^[1] Provided date or earlier after customer approval.

If you have any questions, please do not hesitate to contact your local sales office.

^[2] Last date where orders for unchanged products will be accepted.

^[3] Last date for delivery of unchanged products. Delivery of changed products can be earlier (see Intended start of delivery) and depends on approval.

Several changes affecting products TLE926x

MyICP links PCN 2021-113-A8





Data sheets download

> MyICP links to the Infineon data base

Sales Code	Data sheet folder	Revision
TLE9261-3BQX	MyICP (Link)	Rev. 1.2
TLE9261-3BQX V33	MyICP (<u>Link</u>)	
TLE9261BQX	MyICP (<u>Link</u>)	
TLE9261BQX V33	MyICP (<u>Link</u>)	
TLE9262-3BQX	MyICP (<u>Link</u>)	
TLE9262-3BQX V33	MyICP (<u>Link</u>)	
TLE9262BQX	MyICP (<u>Link</u>)	
TLE9262BQX V33	MyICP (<u>Link</u>)	
TLE9263-3BQX	MyICP (<u>Link</u>)	
TLE9263-3BQX V33	MyICP (<u>Link</u>)	
TLE9263BQX	MyICP (<u>Link</u>)	
TLE9263BQX V33	MyICP (<u>Link</u>)	

TLE926x UMC EMC test reports



> MyICP links to the Infineon data base

FE site	BE site	IBEE Zwickau	SAE J2962-1/2
UMC	Amkor	Pass (<u>CAN/LIN</u> , <u>CAN-FD</u>)	Pass (<u>Link</u>)
UMC	Infineon in-house	Pass (CAN/LIN, CAN-FD)	Pass (refer to Amkor package)



Part of your life. Part of tomorrow.

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Affected products sold to FUTURE ELECTRONICS INC. (4000624)

Sales name	SP number	OPN	Package	Customer part number
TLE9263BQX	SP001611048	TLE9263BQXXUMA1	PG-VQFN-48-31	TLE9263BQXXUMA1



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Sales name	old SP number	old OPN	old Package	new SP number	new OPN	new Package
TLE9261-3BQX	SP001611010	TLE92613BQXXUMA1	PG-VQFN-48-31	SP001611010 SP005427908 SP005427908	TLE92613BQXXUMA1 TLE92613BQXXUMA2 TLE92613BQXXUMA2	PG-VQFN-48-31 PG-VQFN-48-37 PG-VQFN-48-79
TLE9261-3BQX V33	SP001611060	TLE92613BQXV33XUMA1	PG-VQFN-48-31	SP001611060 SP005427910 SP005427910	TLE92613BQXV33XUMA1 TLE92613BQXV33XUMA2 TLE92613BQXV33XUMA2	PG-VQFN-48-31 PG-VQFN-48-37 PG-VQFN-48-79
TLE9261BQX	SP001611020	TLE9261BQXXUMA1	PG-VQFN-48-31	SP001611020 SP005427878 SP005427878	TLE9261BQXXUMA1 TLE9261BQXXUMA2 TLE9261BQXXUMA2	PG-VQFN-48-31 PG-VQFN-48-37 PG-VQFN-48-79
TLE9261BQX V33	SP001611024	TLE9261BQXV33XUMA1	PG-VQFN-48-31	SP001611024 SP005427905 SP005427905	TLE9261BQXV33XUMA1 TLE9261BQXV33XUMA2 TLE9261BQXV33XUMA2	PG-VQFN-48-31 PG-VQFN-48-37 PG-VQFN-48-79
TLE9262-3BQX	SP001611028	TLE92623BQXXUMA1	PG-VQFN-48-31	SP001611028 SP005427921 SP005427921	TLE92623BQXXUMA1 TLE92623BQXXUMA2 TLE92623BQXXUMA2	PG-VQFN-48-31 PG-VQFN-48-37 PG-VQFN-48-79
TLE9262-3BQX V33	SP001611032	TLE92623BQXV33XUMA1	PG-VQFN-48-31	SP001611032 SP005427928 SP005427928	TLE92623BQXV33XUMA1 TLE92623BQXV33XUMA2 TLE92623BQXV33XUMA2	PG-VQFN-48-31 PG-VQFN-48-37 PG-VQFN-48-79
TLE9262BQX	SP001611036	TLE9262BQXXUMA1	PG-VQFN-48-31	SP001611036 SP005427911 SP005427911	TLE9262BQXXUMA1 TLE9262BQXXUMA2 TLE9262BQXXUMA2	PG-VQFN-48-31 PG-VQFN-48-37 PG-VQFN-48-79
TLE9262BQX V33	SP001611056	TLE9262BQXV33XUMA1	PG-VQFN-48-31	SP001611056 SP005427916 SP005427916	TLE9262BQXV33XUMA1 TLE9262BQXV33XUMA2 TLE9262BQXV33XUMA2	PG-VQFN-48-31 PG-VQFN-48-37 PG-VQFN-48-79
TLE9263-3BQX	SP001611040	TLE92633BQXXUMA1	PG-VQFN-48-31	SP001611040 SP005427937 SP005427937	TLE92633BQXXUMA1 TLE92633BQXXUMA2 TLE92633BQXXUMA2	PG-VQFN-48-31 PG-VQFN-48-37 PG-VQFN-48-79
TLE9263-3BQX V33	SP001611044	TLE92633BQXV33XUMA1	PG-VQFN-48-31	SP001611044 SP005427943 SP005427943	TLE92633BQXV33XUMA1 TLE92633BQXV33XUMA2 TLE92633BQXV33XUMA2	PG-VQFN-48-31 PG-VQFN-48-37 PG-VQFN-48-79
TLE9263BQX	SP001611048	TLE9263BQXXUMA1	PG-VQFN-48-31	SP001611048 SP005427932 SP005427932	TLE9263BQXXUMA1 TLE9263BQXXUMA2 TLE9263BQXXUMA2	PG-VQFN-48-31 PG-VQFN-48-37 PG-VQFN-48-79
TLE9263BQX V33	SP001611052	TLE9263BQXV33XUMA1	PG-VQFN-48-31	SP001611052 SP005427935 SP005427935	TLE9263BQXV33XUMA1 TLE9263BQXV33XUMA2 TLE9263BQXV33XUMA2	PG-VQFN-48-31 PG-VQFN-48-37 PG-VQFN-48-79



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Sales name	old SP number	old OPN	old Package	new SP number	new OPN	new Package





PCN N° 2021-113-A8

Several changes affecting products TLE926x

Sales name	old SP number	old OPN	old Package	new SP number	new OPN	new Package